



High Heat load Analysis and Design

Design of the Extreme Conditions Beamline at Diamond Light Source

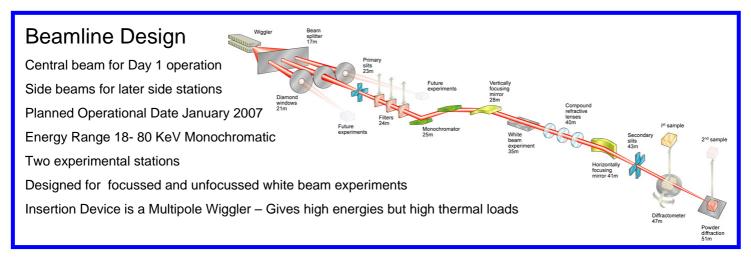
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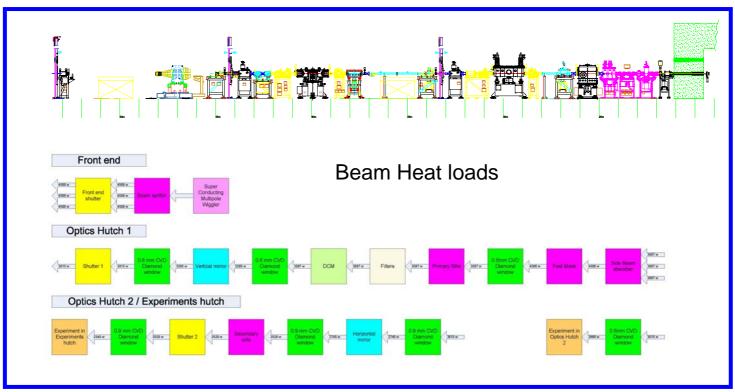
Beamline Science

The study of materials under high pressures and temperatures is a rapidly-expanding field, impacting on a diverse range of fields, including fundamental physics and chemistry, earth and planetary science, bio-molecular science, and research into novel materials.

Synchrotron diffraction experiments are fundamental to the study of material properties under extreme conditions. Intense, very high-energy X-rays from a 3rd generation source can penetrate into complex sample assemblies, and can be collimated to a few μ m, permitting detailed mapping of structural order or disorder, chemical fingerprint, or single crystal structure determination.

This beamline will provide both white and monochromatic high-energy X-rays in both focused and unfocused mode in the range up to 100 keV range.





Super Conducting Multipole Wiggler

Field Strength 3.5T Max

Period length 60mm

No of periods 24

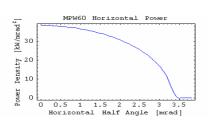
K Gamma 19.6

Central Beam size 0.5mrad(H). 0.4mrad (V)

Supplier Budker Insitute of Nuclear

Physics

Source





Shutters

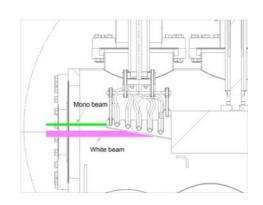
Component - Shutter

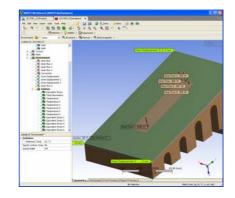
Problem - Focussed heat load

Solution – Beryllium brazed to copper to allow heat load through thickness of beryllium

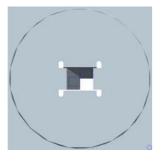
- 2mm thick Beryllium layer brazed to copper absorber
- Suitable for line focussed beam and full white beam.
- 2mm gives 11.5mm along beam direction, absorbs 41.1% of beam power

Layer	Heat load (W)	Max Temp (°C)	Max stress (MPa)
Be 1	488	152	289
Be 2	407	151	276
Be 3	350	149	262
Be 4	305	146	250
Copper	2699	144	152





Slits



Component - Slits

Problem - High heat causes high stresses at corner

Solution - Novel design of edge profile with key hole slots gives sharp corner edges and reduced thermal stresses



Windows

Component - Window

Problem – Removal of low energy photons from beam

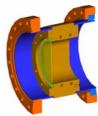
Solution - CVD Diamond disc diffusion bonded via molybdenum ring to water cooled copper absorber.

Also acts as a visual Beam position monitor, electronic beam position monitor and vacuum boundary

component







Three sizes of windows, 105mm Dia 0.9 mmThk, 63mm 0.6mm Thk, 34mm Dia 0.6mm Thk.

Each using Thermal Grade CVD Diamond produced by element6

Diffusion bonded via molybdenum ring to Copper absorber Designed to absorb (810w) 18% of incident power

Energy	nergy Bragg Angle	
18 KeV	6.3 degrees	14.6 µRad
80 Kev	1.4 degrees	3.24 µRad

Silicon (1,1,1)

Crystal rotation limited to 11 degrees

Crystals rotated by micro-pusher operating stiff tangent arm located in stiff bearings

Angle measured using Renisaw RESR 413 ring and RGH readhead to give 0.05 µRad resolution

Crystals cooled by LN2

First crystal bragg rotation stage mounted on linear stage

1st Crystal is 172mm long, 50mm wide, 70mm deep. Sandwiched between LN 2 cooled copper blocks

FEA of Heat load gives a combined thermal and structural slope error of 1 µRad when limited to a beam load of 550watts. Equivalent to 0.16mRad x 0.16mRad beam size at 300mA

DCM

